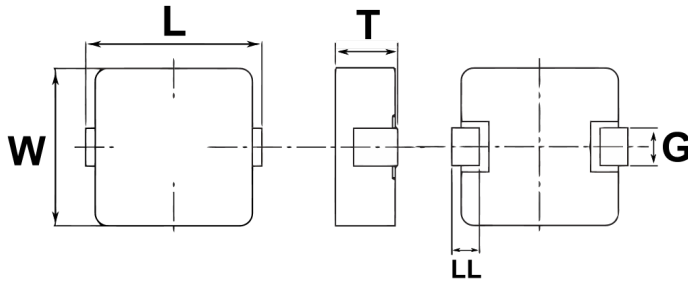


## MPC0750LR60C

Aliases (UPIA0750LR60C0)

Not for New Design

KEMET, MPC, Metal Composite, 20%, 600 nH, 3126



Click [here](#) for the 3D model.

Dimensions	
Chip Size	3126
L	8mm MAX
W	6.7mm +/-0.3mm
T	5mm MAX
G	2mm +/-0.3mm

Packaging Specifications	
Packaging	T&R, 330mm
Packaging Quantity	1000

General Information	
Series	MPC
Style	SMD Molded
Core	Metal Composite
Description	Shielded, Surface Mount Inductor
Features	High Speed, Large Current DC/DC Converter
RoHS	Yes

Specifications	
Inductance	600 nH
Inductance Tolerance	20%
Temperature Range	-40/+125°C
Rated Temperature	120°C
Shielded	true
Current	19 Amps (Isat, 20% Drop In Inductance), 17 Amps (Irms, 40C Rise By Self Heating)
DC Resistance	2.3 mOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.